


PCN Number:	20131220003	PCN Date:	12/27/2013
Title:	Conversion to Cu bond wire		
Customer Contact:	PCN Manager	Phone:	+1(214)480-6037
Dept:	Quality Services		
Proposed 1st Ship Date:	03/27/2014	Estimated Sample Availability:	12/27/2013
Change Type:			
<input type="checkbox"/>	Assembly Site	<input checked="" type="checkbox"/>	Assembly Process
<input type="checkbox"/>	Design	<input type="checkbox"/>	Electrical Specification
<input type="checkbox"/>	Test Site	<input type="checkbox"/>	Packing/Shipping/Labeling
<input type="checkbox"/>	Wafer Bump Site	<input type="checkbox"/>	Wafer Bump Material
<input type="checkbox"/>	Wafer Fab Site	<input type="checkbox"/>	Wafer Fab Materials
<input type="checkbox"/>			Part number change
PCN Details			
Description of Change:			
Texas Instruments is pleased to announce the qualification of Cu as a bond wire option for the selected devices shown below. All listed devices will remain in current assembly facility and there will be no other BOM changes.			
Reason for Change:			
Continuity of supply. 1) To align with world technology trends and use wiring with enhanced mechanical and electrical properties 2) Maximize flexibility within our Assembly/Test production sites. 3) Cu is easier to obtain and stock			
Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):			
None			
Changes to product identification resulting from this PCN:			
None affecting physical device marking. The 'REV' number on the labels will change for the CC112x/CC1175 and the CC2530FxxCRHA products.			
 <p>The image shows a sample device label for SN74LS07NSR. It includes the Texas Instruments logo, 'MADE IN: Malaysia', MSL ratings (MSL 2 /260C/1 YEAR and MSL 1 /235C/UNLIM), a seal date of 03/29/04, and an item number of 5A (L)T0:1750. A QR code is present. The part number is (1P) SN74LS07NSR, with (Q) 2000 and (D) 0336. The lot number is (31T) LOT: 3959047MLA. The factory code is (4W) TKY (1T) 7523483SI2. The revision number (REV) is (2P) REV: 0033317, which is highlighted with a red box and an arrow pointing to the text 'This is the REV number.' Other markings include (V) 0033317, (20L) CS0: SHE, (21L) CCO:USA, and (22L) AS0: MLA, (23L) ACO: MYS.</p>			
Note that the following register changes will apply to the following products:			
CC112x/CC1175: Register 0x90 PARTVERSION. The new Reset value is 0x23.			
CC2530F12CRHA and CC2530F25CRHA: Register 0x6249 CHVER. The chip revision number will change.			

Product Affected:			
CC1120RHBR	CC1125ARHBR	CC1175RHBT	CC1201RHBT
CC1120RHBT	CC1125RHBR	CC1200RHBR	CC2530F12CRHA
CC1121RHBR	CC1125RHBT	CC1200RHBT	CC2530F25CRHA
CC1121RHBT	CC1175RHBR	CC1201RHBR	

Reference Qualification Data				
This qualification has been developed for the validation of this change. The qualification data validates that the proposed change meets the applicable released technical specifications.				
Qual Vehicle: CC2533F96RHA (MSL 3-260C)				
Package Construction Details				
Assembly Site:	Clark AT	Mold Compound:	4208625	
# Pins-Designator, Family:	40-RHA, VQFN	Mount Compound:	4207123	
Lead Finish	NiPdAu	Bond Wire:	0.8mil Cu	
Qualification: <input type="checkbox"/> Plan <input checked="" type="checkbox"/> Test Results				
Reliability Test	Conditions	Sample Size/Fail		
		Lot#1	Lot#2	Lot#3
** High Temp Operating Life	125C (168, 500, 1000 Hrs)	39/0	39/0	38/0
High Temp. Storage Bake	150C (168, 300, 600 hrs)	77/0	77/0	77/0
**Biased Temp. Humidity	85C/85%RH (168, 600, 800 Hrs).	26/0	26/0	25/0
**Unbiased HAST	110C/85%RH/17.7 psia (96, 264 hrs)	77/0	77/0	77/0
**T/C -65C/150C	-65C/+150C (500 Cyc)	26/0	26/0	25/0
**T/C -55C/125C	-55C/+125C (200, 700 Cyc)	77/0	77/0	77/0
ESD CDM	+/- 100V, 250V, 500V	3/0	3/0	3/0
ESD HBM	+/- 500V, 1000V	3/0	3/0	3/0
Latch-up	(per JESD78)	6/0	3/0	3/0
Notes **- Preconditioning sequence: Level 3-260C.				

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com